

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Seok-Bo SHIM</td><td>06/27/2008</td></tr><tr><td>Mi-Hye KIM</td><td>06/27/2008</td></tr></tbody></table>	Name	Execution Date	Seok-Bo SHIM	06/27/2008	Mi-Hye KIM	06/27/2008			
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RECEIVING PARTY DATA									
<table border="1"><tr><td>Name:</td><td>HYNIX SEMICONDUCTOR, INC.</td></tr><tr><td>Street Address:</td><td>San 136-1, Ami-ri, Bubal-eub, Ichon-shi</td></tr><tr><td>City:</td><td>Kyoungki-do 467-860</td></tr><tr><td>State/Country:</td><td>REPUBLIC OF KOREA</td></tr></table>	Name:	HYNIX SEMICONDUCTOR, INC.	Street Address:	San 136-1, Ami-ri, Bubal-eub, Ichon-shi	City:	Kyoungki-do 467-860	State/Country:	REPUBLIC OF KOREA	
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PROPERTY NUMBERS Total: 1									
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>12164190</td></tr></tbody></table>	Property Type	Number	Application Number:	12164190					
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Application Number:	12164190								
CORRESPONDENCE DATA									
Fax Number: (202)408-0924 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
Phone: (202) 371-8976									
Email: firm@rabinberdo.com									
Correspondent Name: Steven M. Rabin									
Address Line 1: Suite 500, 1101 14th Street, N.W.									
Address Line 4: Washington, DISTRICT OF COLUMBIA 20005									
ATTORNEY DOCKET NUMBER:	SHIN 210								
NAME OF SUBMITTER:	Steven M. Rabin								
Total Attachments: 2 source=SHIN210-Ass#page1.tif source=SHIN210-Ass#page2.tif									

OP \$40.00 12164190

ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENT

WHEREAS SHIM, Seok-Bo and KIM, Mi-Hye,
 hereinafter referred to collectively as the assignor, has invented a certain improvement relating to _____
DELAY LOCKED LOOP CIRCUIT AND METHOD THEREOF

[X] the inventor(s) declaration for said application being executed concurrently with the execution of this instrument; said application to be filed in the United States Patent and Trademark Office;
 [X] said application having been filed in the United States Patent and Trademark Office on June 30, 2008, authorization being hereby given to my attorneys, Steven M. Rabin, Robert H. Berdo, Jr., Phillip G. Avruch, and Allen Wood of RABIN & BERDO, P.C., 1101 14th Street, N.W., Washington, D.C. 20005, to insert here in parentheses (Application Serial No. 12/164,190) the application serial number of said application when known;

AND WHEREAS IIynix Semiconductor, Inc. of San 136-1, Ami-ri, Bubal-eub, Ichon-shi, Kyoungki-do 467-860, Republic of Korea, hereinafter referred to as the assignee, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof;

NOW THIS WITNESSETH, that for and in consideration of One Dollar (\$1.00), and other good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

EXECUTED, this 27 day of June, 2008.

WITNESSES:

Signature: [Signature]
 Name: HWANGL, Ji-Yeon
 Address: Seoul

ASSIGNOR:

Signature: [Signature]
 Name: SHIM, Seok-Bo

Signature: _____
 Name: _____
 Address: _____

RABIN & BERDO, P.C., Washington, D.C.

ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENT

Page 2 of 2

WITNESSES:

Signature: [Signature]
Name: HWANG, SI-YEON
Address: Seoul

Signature: _____
Name: _____
Address: _____

WITNESSES:

Signature: _____
Name: _____
Address: _____

Signature: _____
Name: _____
Address: _____

WITNESSES:

Signature: _____
Name: _____
Address: _____

Signature: _____
Name: _____
Address: _____

ASSIGNOR:

Signature: [Signature]
Name: KIM, Mi-Hye

ASSIGNOR:

Signature: _____
Name: _____

ASSIGNOR:

Signature: _____
Name: _____

RABIN & BERDO, P.C., Washington, D.C.